

# 1A, Low Noise, Ultra High PSRR, Low-Dropout Linear Regulator

## 1 FEATURES

- **Input Voltage Range: 2.2V to 6V**
- **Output Voltage Range:**
  - **Fixed Option: 0.8V, 1.0V, 1.2V, 1.8V, 2.5V, 3V, 3.3V and 5.0V**
  - **Adjustable Option: 0.8V to 5.5V**
- **Up to 1A Load Current**
- **Ultra High PSRR: 66dB at 1kHz**
- **Excellent Noise Immunity**
- **Very Low Dropout: 175mV Typical at 1A**
- **-40°C to 125°C Operating Junction Temperature Range**
- **Fast Response Over Load and Line Transient**
- **Stable with a 4.7µF Output Ceramic Capacitor**
- **Accurate Output Voltage ±3%**
- **Enable Control**
- **Over-Current Protection**
- **Over-Temperature Protection**

## 2 APPLICATIONS

- **Telecom/Networking Cards**
- **Motherboards/Peripheral Cards**
- **Industrial Applications**
- **Wireless Infrastructures**
- **Set-Top Boxes**
- **Medical Equipments**
- **Notebook Computers**
- **Battery Powered Systems**

## 3 DESCRIPTIONS

The RS3242 is a high performance positive low dropout (LDO) regulator designed for applications requiring very low dropout voltage and ultra-high Power Supply Ripple Rejection (PSRR) at up to 1A. The input voltage range is from 2.2V to 6V and the output voltage is programmable as low as 0.8V. A P-MOSFET switch provides excellent transient response with just a 4.7µF ceramic output capacitor. The external enable control effectively reduces power dissipation while shutdown and further output noise immunity is achieved through bypass capacitor on NR pin.

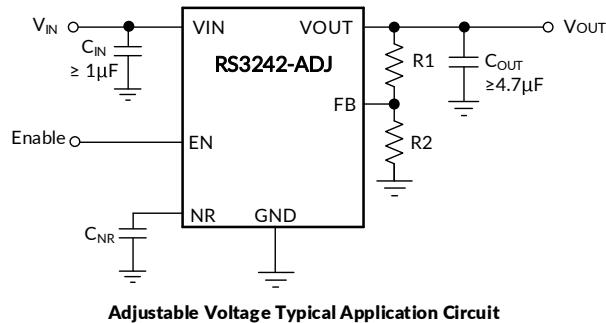
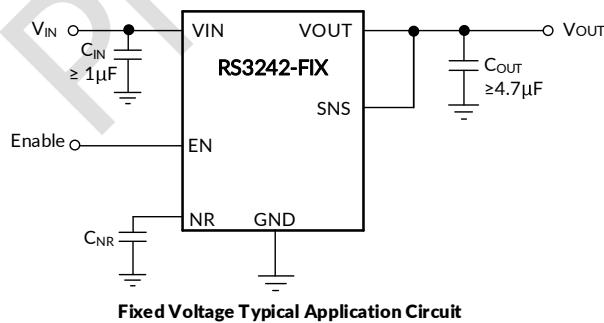
The device is available in the DFN3X3-8 package and is specified from -40°C to 125°C.

### Device Information <sup>(1)</sup>

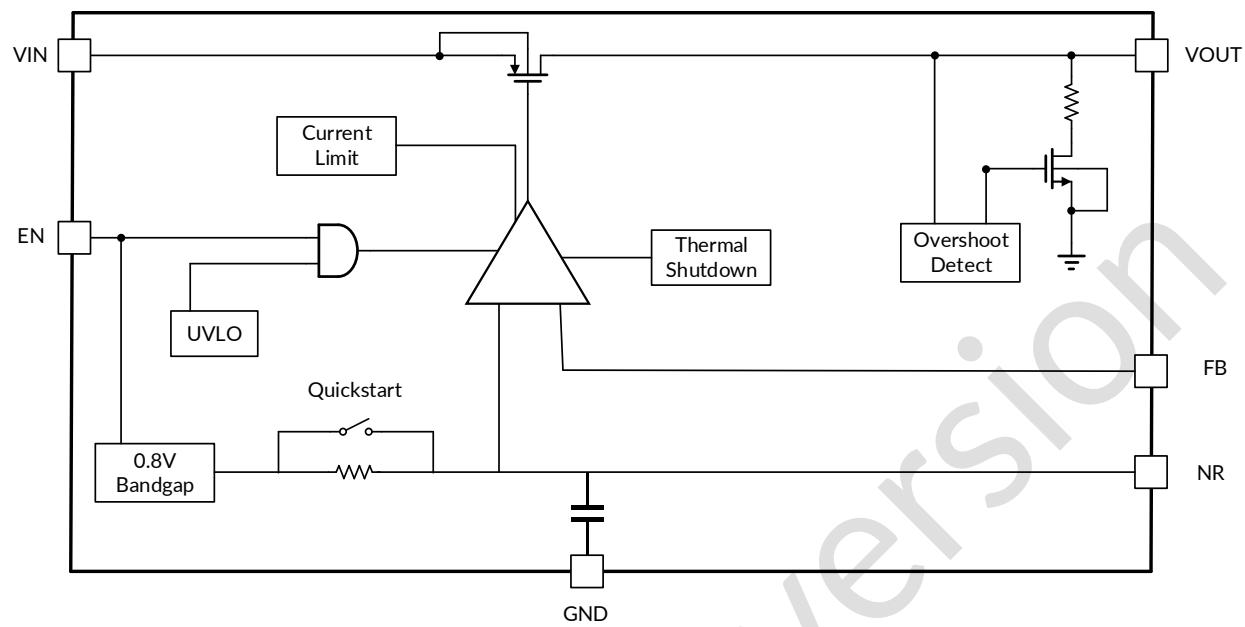
PART NUMBER	PACKAGE	BODY SIZE (NOM)
RS3242	DFN3X3-8	3.00mm×3.00mm

(1) For all available packages, see the orderable addendum at the next page of the data sheet.

## 4 TYPICAL APPLICATION



## 5 FUNCTIONAL BLOCK DIAGRAM



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## 6 REVISION HISTORY

Note: Page numbers for previous revisions may different from page numbers in the current version.

VERSION	Change Date	Change Item
A.0	2024/12/17	Preliminary version completed
A.0.1	2025/07/18	1. Update PACKAGE/ORDERING INFORMATION 2. Modify PIN CONFIGURATION AND FUNCTIONS 3. Update KEY PARAMETER LIST OF TAPE AND REEL
A.0.2	2025/09/28	Change DFN3X3-8 PACKAGE OUTLINE DIMENSIONS

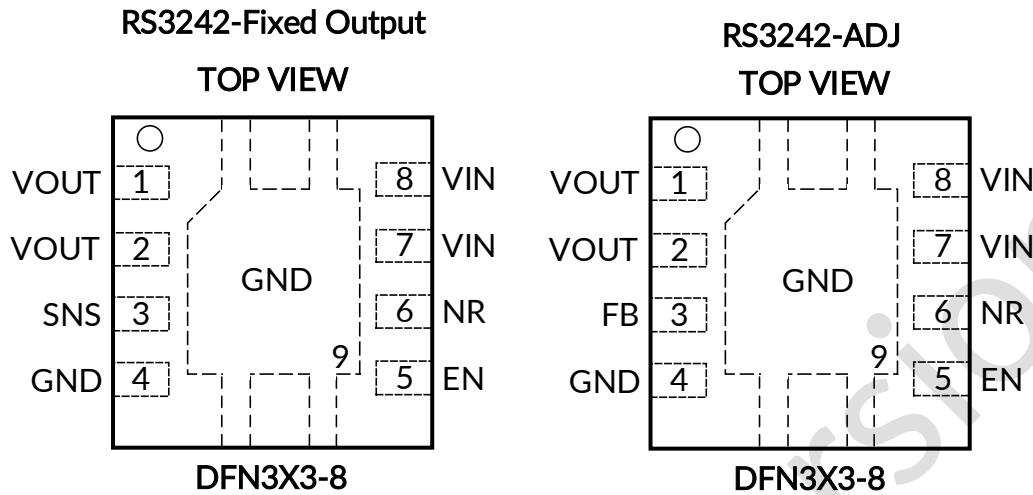
## 7 PACKAGE/ORDERING INFORMATION <sup>(1)</sup>

PRODUCT	ORDERING NUMBER	V <sub>OUT</sub> (V)	V <sub>OUT</sub> Accuracy	PACKAGE LEAD	PACKAGE MARKING <sup>(2)</sup>	MSL <sup>(3)</sup>	PACKAGE OPTION
RS3242	RS3242-0.8XDC8	0.8	±3%	DFN3X3-8	RS3242A	MSL3	Tape and Reel, 5000
	RS3242-1.0XDC8	1.0	±3%	DFN3X3-8	RS3242B	MSL3	Tape and Reel, 5000
	RS3242-1.2XDC8	1.2	±3%	DFN3X3-8	RS3242C	MSL3	Tape and Reel, 5000
	RS3242-1.8XDC8	1.8	±3%	DFN3X3-8	RS3242D	MSL3	Tape and Reel, 5000
	RS3242-2.5XDC8	2.5	±3%	DFN3X3-8	RS3242E	MSL3	Tape and Reel, 5000
	RS3242-3.0XDC8	3.0	±3%	DFN3X3-8	RS3242F	MSL3	Tape and Reel, 5000
	RS3242-3.3XDC8	3.3	±3%	DFN3X3-8	RS3242G	MSL3	Tape and Reel, 5000
	RS3242-5.0XDC8	5.0	±3%	DFN3X3-8	RS3242H	MSL3	Tape and Reel, 5000
	RS3242-ADJ8XDC8	ADJ	±3%	DFN3X3-8	RS3242K	MSL3	Tape and Reel, 5000

**NOTE:**

- (1) This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the right-hand navigation.
- (2) There may be additional marking, which relates to the lot trace code information (data code and vendor code), the logo or the environmental category on the device.
- (3) RUNIC classify the MSL level with using the common preconditioning setting in our assembly factory conforming to the JEDEC industrial standard J-STD-20F. Please align with RUNIC if your end application is quite critical to the preconditioning setting or if you have special requirement.

## 8 PIN CONFIGURATION AND FUNCTIONS



### PIN DESCRIPTION

PIN	NAME	FUNCTION
1, 2	VOUT	Output of the regulator. Decouple this pin to GND with at least $4.7\mu\text{F}$ for stability.
3	FB	Feedback voltage input. This pin is used to set the desired output voltage via an external resistive divider. The feedback reference voltage is 0.8V typically.
	SNS	Output Voltage Sense Input Pin (fixed voltage version only). Connect this pin to the load side of the output trace only in the fixed voltage version
4, 9 (Exposed Pad)	GND	System ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.
5	EN	Enable control input. Connecting this pin to logic high enables the regulator or driving this pin low puts it into shutdown mode. EN can be connected to IN if not used. (EN pin is not allowed to be left floating.)
6	NR	Noise reduction input. Decouple this pin to GND with an external capacitor can not only reduce output noise to very low levels but also slow down the VOUT rise like a soft-start behavior.
7, 8	VIN	Supply input. A minimum of $1\mu\text{F}$ ceramic capacitor should be placed as close as possible to this pin for better noise rejection.

## 9 SPECIFICATIONS

### 9.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

			MIN	MAX	UNIT
V <sub>IN</sub>	Input Voltage		-0.3	7	V
V <sub>EN</sub>	Enable Input Voltage		-0.3	7	V
I <sub>OUT</sub>	Current		Internally limited		A
θ <sub>JA</sub>	Package Thermal Impedance <sup>(2)</sup>	DFN3X3-8		35	°C/W
T <sub>J</sub>	Junction Temperature <sup>(3)</sup>		-40	150	°C
T <sub>STG</sub>	Storage Temperature		-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) θ<sub>JA</sub> is measured under natural convection (still air) at T<sub>A</sub> = 25°C with the component mounted on a high effective-thermal-conductivity four-layer test board on a JEDEC 51-7 thermal measurement standard. θ<sub>JC</sub> is measured at the exposed pad of the package.

(3) The maximum power dissipation is a function of T<sub>J(MAX)</sub>, R<sub>θJA</sub>, and T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is P<sub>D</sub> = (T<sub>J(MAX)</sub> - T<sub>A</sub>) / R<sub>θJA</sub>. All numbers apply for packages soldered directly onto a PCB.

### 9.2 ESD Ratings

The following ESD information is provided for handling of ESD-sensitive devices in an ESD protected area only.

		VALUE	UNIT	
V <sub>(ESD)</sub>	Electrostatic discharge	Human-Body Model (HBM), ANSI/ESDA/JEDEC JS001-2024	±2000	V
		Charge Device Model (CDM), ANSI/ESDA/JEDEC JS-002-2022	±1000	V



#### ESD SENSITIVITY CAUTION

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 9.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V <sub>IN</sub>	Input Voltage Range on V <sub>IN</sub>	2.2	6	V
V <sub>OUT</sub>	Output Voltage	0.8	5.5	V
I <sub>OUT</sub>	Output Current Range on I <sub>OUT</sub>	0	1000	mA
C <sub>OUT</sub>	Output Capacitor	4.7	100	μF
T <sub>J</sub>	Junction Temperature	-40	125	°C

## 9.4 Electrical Characteristics

Over operating temperature range ( $-40^{\circ}\text{C} \leq T_J \leq 125^{\circ}\text{C}$ ),  $V_{\text{IN}}=V_{\text{OUT}}(\text{nom})+0.5\text{V}$  or  $2.2\text{V}$ ,  $V_{\text{OUT}} = 0.8\text{V}$  and  $5.5\text{V}$ ,  $I_{\text{OUT}} = 1\text{mA}$ ,  $V_{\text{EN}} = 2.2\text{V}$ ,  $C_{\text{NR}} = 10\text{nF}$ ,  $C_{\text{OUT}} = 4.7\mu\text{F}$ , (unless otherwise noted); typical values are at  $T_J=25^{\circ}\text{C}$ .

PARAMETER	SYMBOL	CONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
<b>POWER SUPPLY AND CURRENTS</b>						
Input Voltage <sup>(1)</sup>	$V_{\text{IN}}$		2.2		6	V
Under Voltage Lockout	UVLO	$V_{\text{IN}}$ rising		2.1		V
Hysteresis	$V_{\text{HYS}}$	$V_{\text{IN}}$ falling		200		mV
Quiescent Current	$I_{\text{Q}}$	$V_{\text{EN}} = 1.2\text{V}$ , $I_{\text{OUT}} = 0\text{mA}$		125		$\mu\text{A}$
Ground Pin Current	$I_{\text{GND}}$	$V_{\text{EN}} = 1.2\text{V}$ , $I_{\text{OUT}} = 1\text{A}$ , $V_{\text{OUT}}=3.3\text{V}$		485		$\mu\text{A}$
Shutdown Current	$I_{\text{SD}}$	$V_{\text{EN}} = 0\text{V}$ , $V_{\text{IN}}=6\text{V}$		0.01		$\mu\text{A}$
<b>OUTPUT VOLTAGE</b>						
Output Voltage Range	$V_{\text{OUT}}$		0.8		5.5	V
Feedback Voltage	$V_{\text{FB}}$	Adjustable Only		0.8		V
Feedback Pin Current	$I_{\text{FB}}$	$V_{\text{IN}} = 6\text{V}$ , $V_{\text{FB}} = 0.8\text{V}$		0.001		$\mu\text{A}$
DC Output Accuracy <sup>(1)</sup>	$\Delta V_{\text{OUT}}$	$V_{\text{IN}}= V_{\text{OUT}}(\text{nom})+0.5\text{V}$ to $6\text{V}$ , $I_{\text{OUT}} = 1\text{mA}$ to $1\text{A}$		$\pm 3$		%
Output Voltage Temperature Coefficient <sup>(4)</sup>	$\frac{\Delta V_{\text{OUT}}}{\Delta T_A \times V_{\text{OUT}}}$	$T_J = -40^{\circ}\text{C} \sim +85^{\circ}\text{C}$ , $I_{\text{OUT}} = 1\text{mA}$	80			ppm/ $^{\circ}\text{C}$
		$T_J = -40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ , $I_{\text{OUT}} = 1\text{mA}$	70			
Line Regulation <sup>(1)</sup>	$\Delta V_{\text{OUT}(\Delta V_{\text{IN}})}$	$V_{\text{IN}} = V_{\text{OUT}} + 0.5\text{V}$ to $6\text{V}$ , $I_{\text{OUT}} = 1\text{mA}$		0.2		%/V
Load Regulation <sup>(1)</sup>	$\Delta V_{\text{OUT}(\Delta I_{\text{OUT}})}$	$V_{\text{IN}} = V_{\text{OUT}} + 0.5\text{V}$ , $I_{\text{OUT}} = 1\text{mA}$ to $1\text{A}$		20		mV
Maximum Output Current <sup>(5)</sup>	$I_{\text{OUTMAX}}$		1			A
<b>DROPOUT VOLTAGE</b>						
Dropout Voltage <sup>(6)</sup>	$V_{\text{DO}}$	$I_{\text{OUT}} = 1\text{A}$	Adjustable Only, $V_{\text{IN}}=2.2\text{V}$ , $\text{FB}=\text{GND}$		320	
			$V_{\text{OUT}} = 3.3\text{V}$		230	
			$V_{\text{OUT}} = 5.0\text{V}$		175	
<b>POWER SUPPLY REJECTION RATIO AND NOISE</b>						
Power Supply Rejection Ratio <sup>(7)</sup>	PSRR	$V_{\text{IN}} = 4.3\text{V}$ , $V_{\text{OUT}} = 3.3\text{V}$ , $C_{\text{NR}} = 10\text{nF}$ , $I_{\text{OUT}} = 750\text{mA}$	$f = 100\text{Hz}$		65	
			$f = 1\text{KHz}$		66	
			$f = 10\text{KHz}$		49	
			$f = 100\text{KHz}$		40	
			$f = 1\text{MHz}$		33	
Output Noise Voltage <sup>(7)</sup>	$V_{\text{N}}$	$\text{BW}= 10\text{Hz}$ to $100\text{kHz}$ , $V_{\text{IN}} = 4.3\text{V}$ , $V_{\text{OUT}} = 3.3\text{V}$ , $I_{\text{OUT}} = 100\text{mA}$	$C_{\text{NR}} = 1\text{nF}$		78	$\mu\text{V}_{\text{RMS}}$
			$C_{\text{NR}} = 10\text{nF}$		47	$\mu\text{V}_{\text{RMS}}$
			$C_{\text{NR}} = 100\text{nF}$		37	$\mu\text{V}_{\text{RMS}}$
<b>ENABLE AND STARTUP TIME</b>						
Enable High (Enabled)	$V_{\text{IH}}$	$V_{\text{IN}} = 2.2\text{V}$ to $6\text{V}$ , $\text{EN}$ rising	1.2			V
Enable Low (Shutdown)	$V_{\text{IL}}$	$V_{\text{IN}} = 2.2\text{V}$ to $6\text{V}$ , $\text{EN}$ falling			0.4	V
Enable Pin Current, Enabled	$I_{\text{EN}}$	$V_{\text{EN}} = V_{\text{IN}} = 6\text{V}$		0.03		$\mu\text{A}$
Output discharge FET Rdson	$R_{\text{DIS}}$	$V_{\text{IN}}=5\text{V}$ , $V_{\text{EN}} < V_{\text{IL}}$ (output disable)		300		$\Omega$
Startup Time	$t_{\text{STR}}$	$V_{\text{OUT}} = 3.3\text{V}$ , $I_{\text{OUT}}=10\text{mA}$ , $C_{\text{OUT}} = 4.7\mu\text{F}$	$C_{\text{NR}} = \text{none}$		55	
			$C_{\text{NR}} = 1\text{nF}$		95	
			$C_{\text{NR}} = 10\text{nF}$		910	

**PROTECTIONS**

Over Current Limit	$I_{LMT}$	$V_{OUT} = 0.85 \times V_{OUT}$		1300		mA
Thermal Shutdown Threshold <sup>(7)</sup>	$T_{SD}$	Shutdown, temperature increasing		155		°C
		Reset, temperature decreasing		135		°C

(1) Minimum  $V_{IN} = V_{OUT} + V_{DO}$  or 2.2V, whichever is greater.

(2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.

(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration.

(4) Output voltage temperature coefficient is defined as the worst-case voltage change divided by the total temperature range.

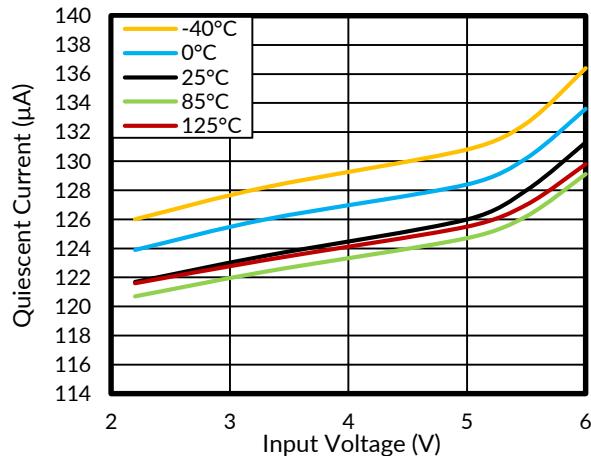
(5) Maximum output current is affected by the PCB layout, size of metal trace, the thermal conduction path between metal layers, ambient temperature and the other environment factors of system. Attention should be paid to the dropout voltage when  $V_{IN} < V_{OUT} + V_{DROP}$ .

(6)  $V_{DROP}$  FT test method: test the  $V_{OUT}$  voltage at  $V_{SET} + V_{DROPMAX}$  with output current.

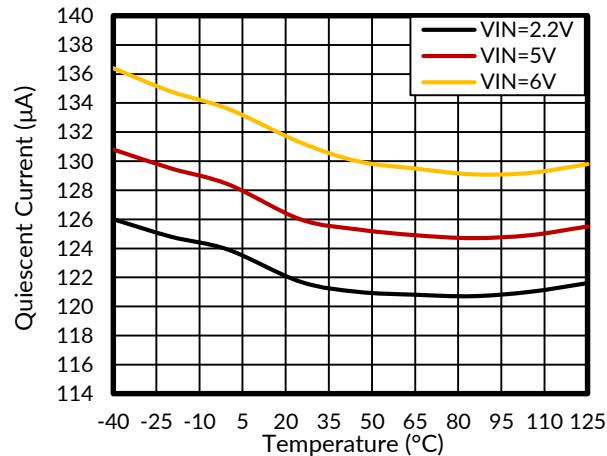
(7) Guaranteed by design and characterization, not a FT item.

## 9.5 Typical Characteristics

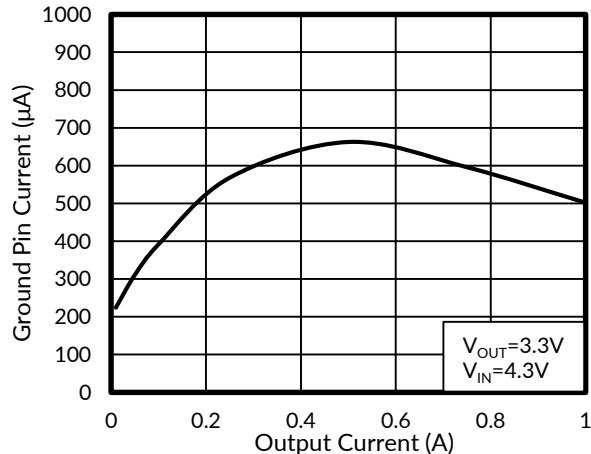
NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.



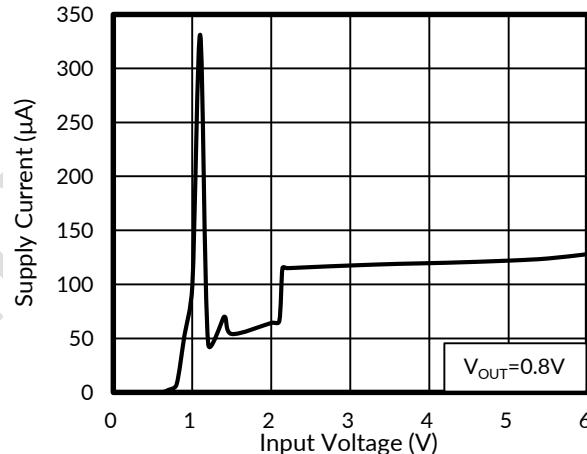
**Figure 1. Quiescent Current vs Input Voltage**



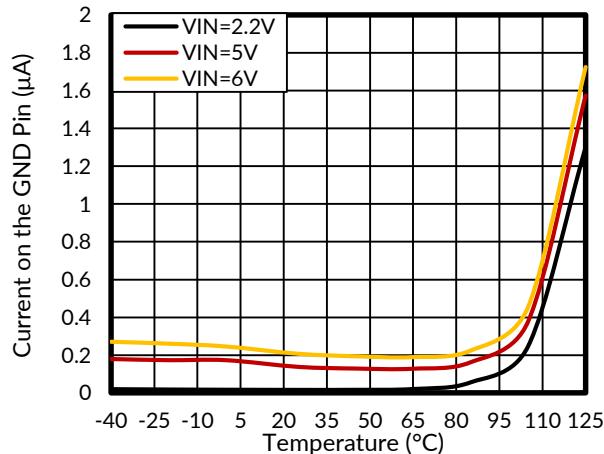
**Figure 2. Quiescent Current vs Temperature**



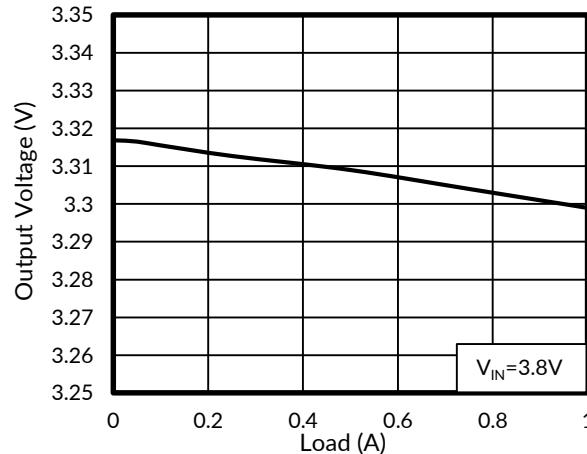
**Figure 3. Ground Pin Current vs Output Current**



**Figure 4. Supply Current vs Input Voltage**



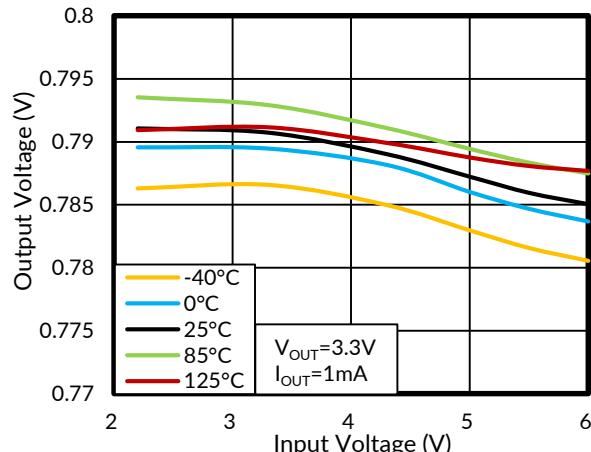
**Figure 5. Shutdown Current vs Temperature**



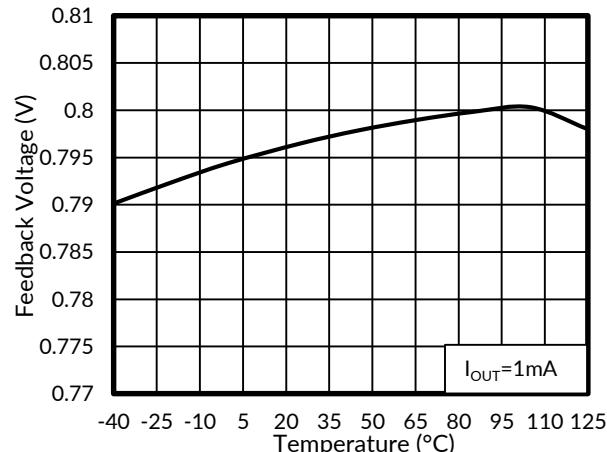
**Figure 6. Load Regulation**

## Typical Characteristics

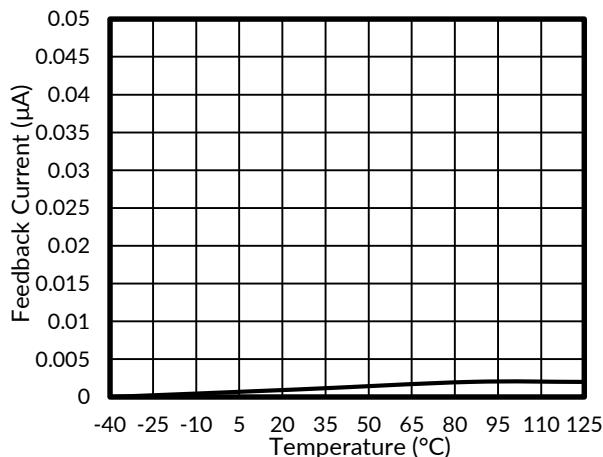
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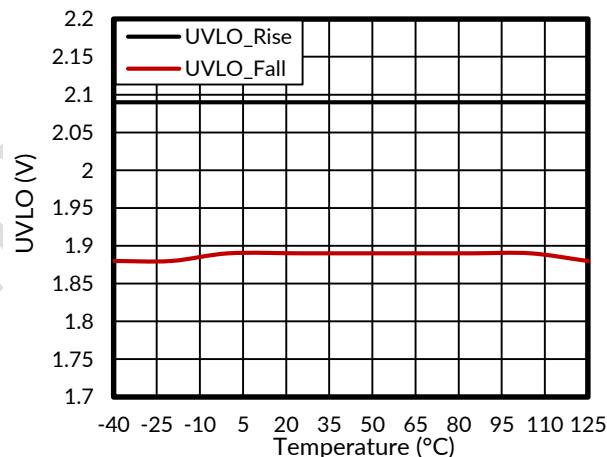
**Figure 7. Line Regulation**



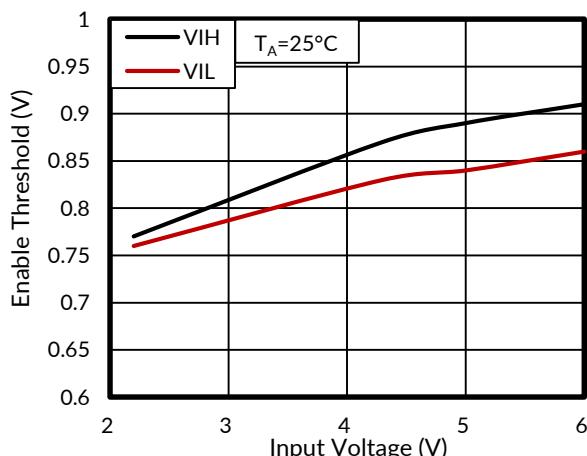
**Figure 8. Feedback Voltage vs Junction Temperature**



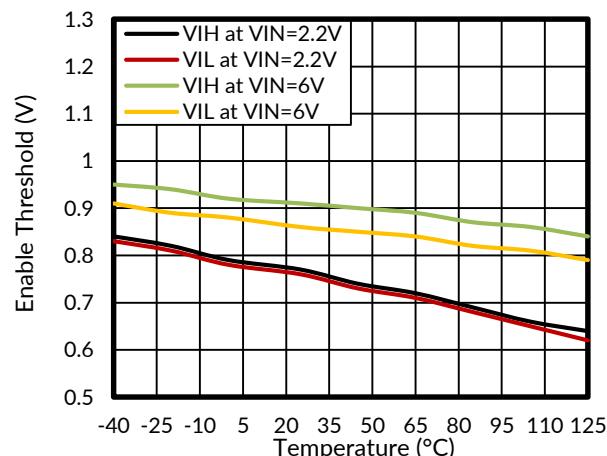
**Figure 9. Feedback Pin Current vs Junction Temperature**



**Figure 10. UVLO vs Junction Temperature**



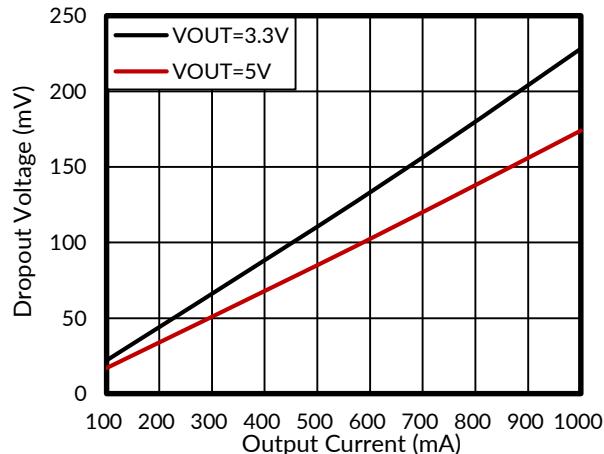
**Figure 11. Enable Threshold vs Input Voltage**



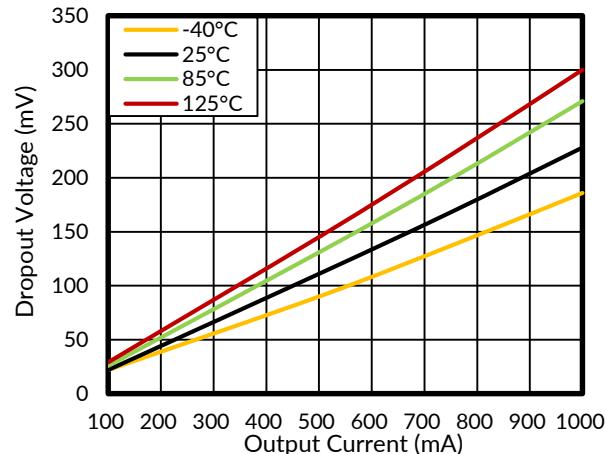
**Figure 12. Enable Threshold vs Junction Temperature**

## Typical Characteristics

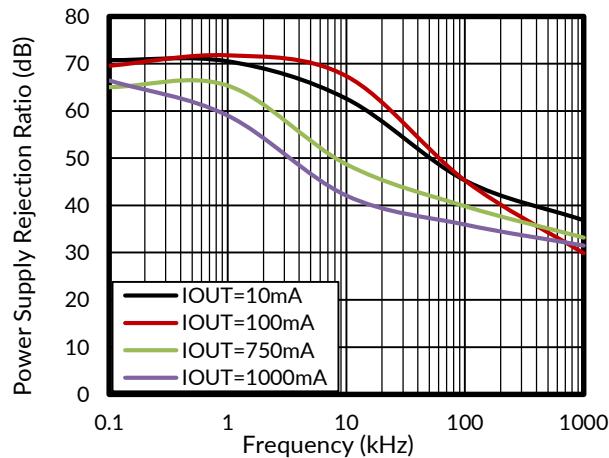
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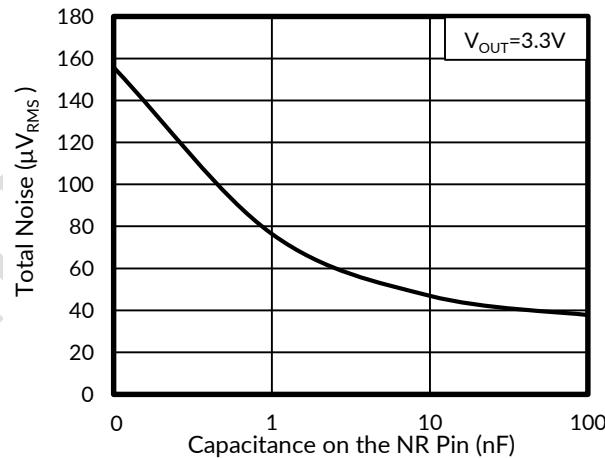
**Figure 13. Dropout Voltage vs Output Current**



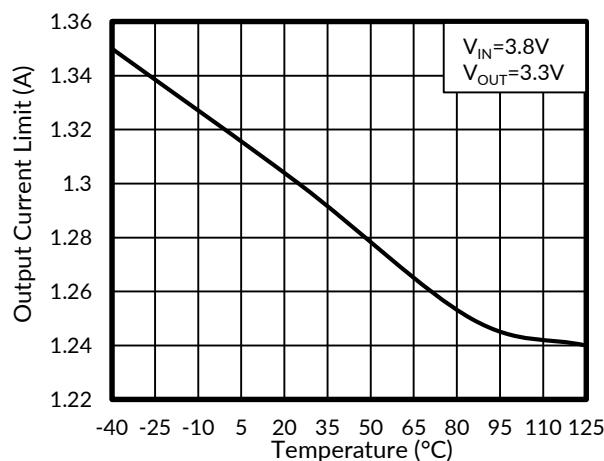
**Figure 14. Dropout Voltage vs Output Current**



**Figure 15. Power Supply Rejection Ratio vs Frequency**



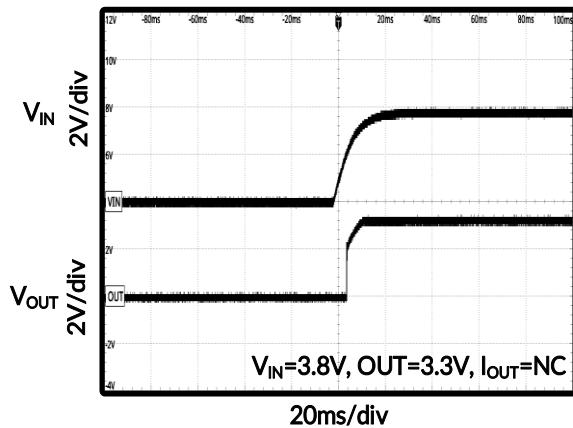
**Figure 16. RMS Noise vs CNR**



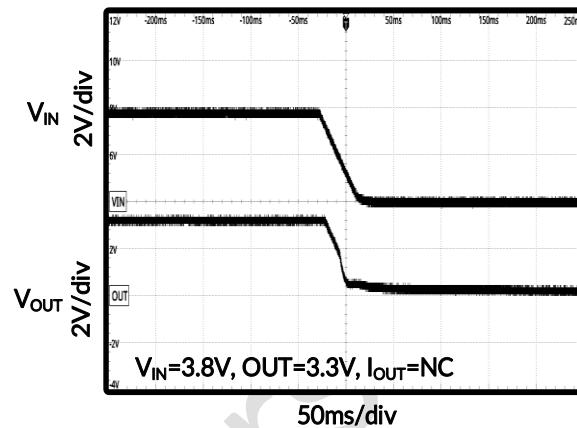
**Figure 17. Output Current Limit vs Temperature**

## Typical Characteristics

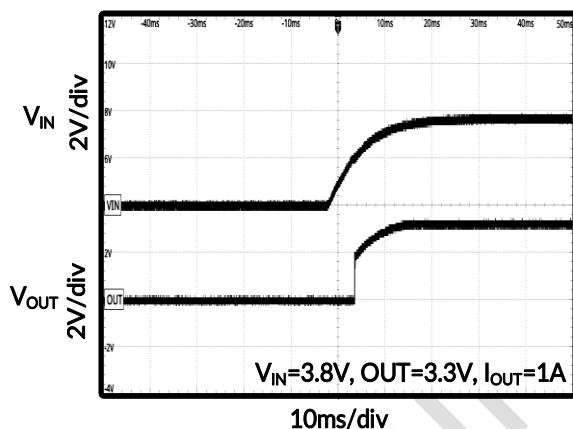
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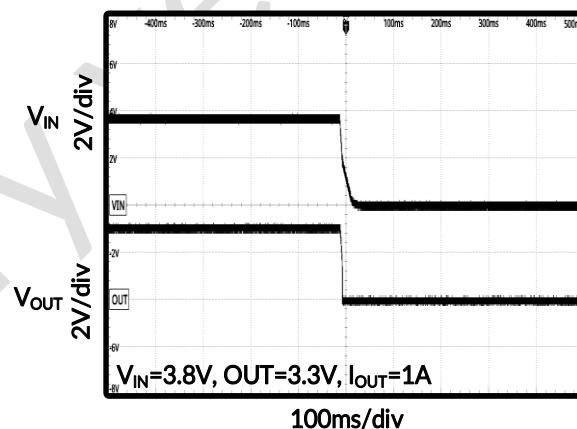
**Figure 18. Power On**



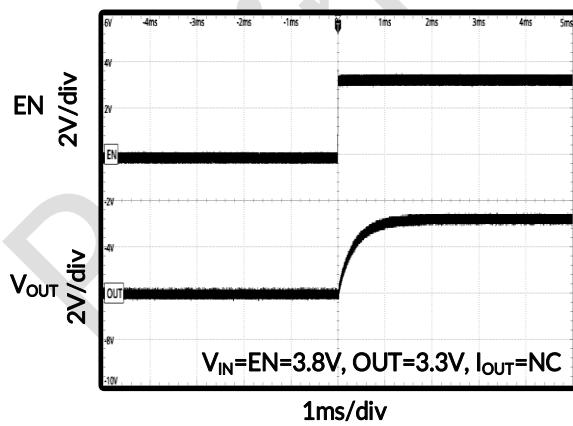
**Figure 19. Power Off**



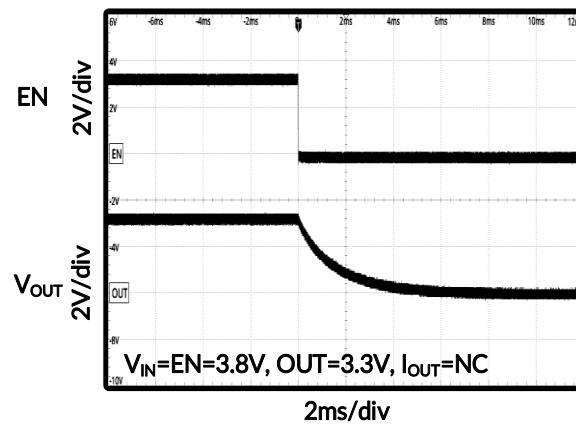
**Figure 20. Power On**



**Figure 21. Power Off**



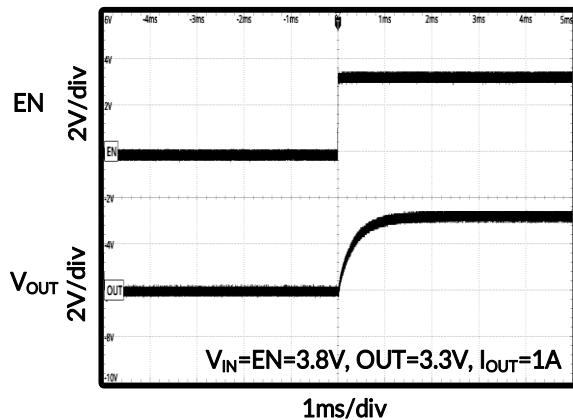
**Figure 22. Turn On**



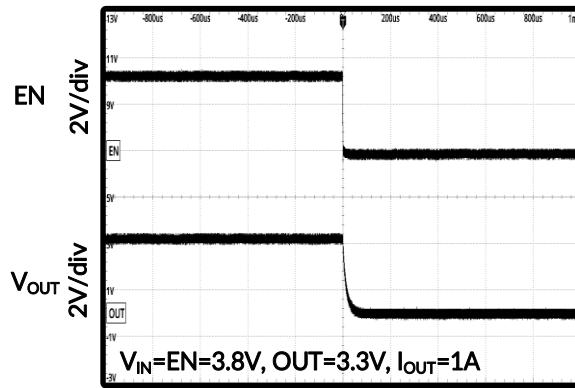
**Figure 23. Turn Off**

## Typical Characteristics

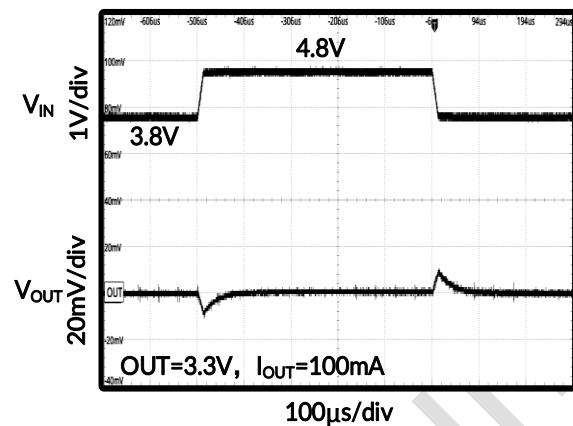
NOTE: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only.



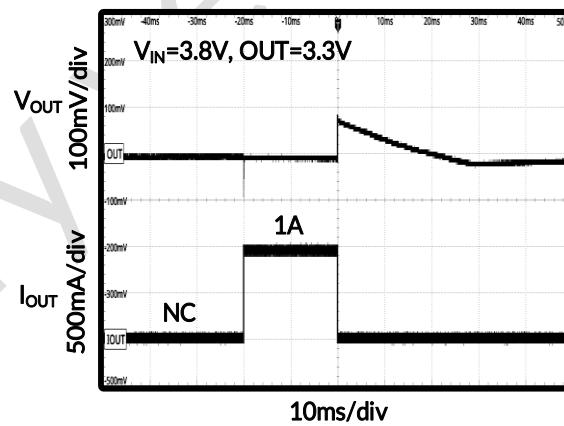
**Figure 24. Turn On**



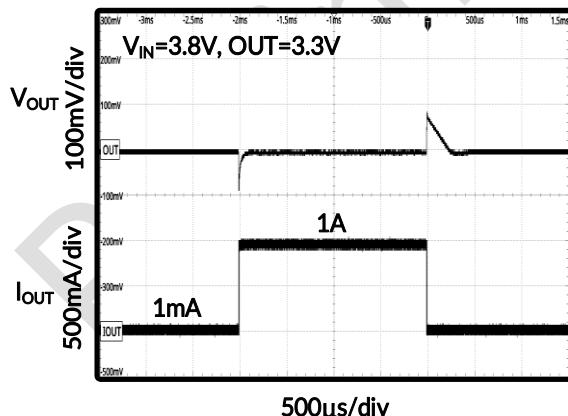
**Figure 25. Turn Off**



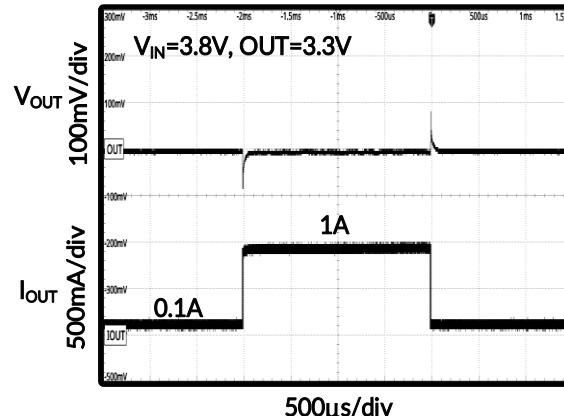
**Figure 26. Line Transient Response**



**Figure 27. Load Transient Response**



**Figure 28. Load Transient Response**



**Figure 29. Load Transient Response**

## 10 FEATURE DESCRIPTION

### 10.1 Internal Current-Limit

The RS3242 internal current-limit helps protect the regulator during fault conditions. During current-limit, the output sources a fixed amount of current that is largely independent of the output voltage. For reliable operation, do not operate the device in current-limit for extended periods of time.

The RS3242 family of devices has a built-in body diode that conducts current when the voltage at the VOUT pin exceeds the voltage at the VIN pin. This current is not limited, so if extended reverse voltage operation is anticipated, external limiting can be appropriate.

### 10.2 Shutdown

The enable pin (EN) is active high and is compatible with standard and low-voltage TTL-CMOS levels. When shutdown capability is not required, the EN pin can be connected to the VIN pin.

### 10.3 Startup and Noise Reduction Capacitor

Fixed voltage versions of the RS3242 family of devices use a quick-start circuit to fast-charge the noise reduction capacitor,  $C_{NR}$ , if present. This architecture allows the combination of very-low output noise and fast startup times. The NR pin is high impedance so a low-leakage  $C_{NR}$  capacitor must be used. Most ceramic capacitors are appropriate in this configuration. A high-quality, C0G-type (NPO) dielectric ceramic capacitor is recommended for  $C_{NR}$  when used in environments where abrupt changes in temperature can occur.

### 10.4 Undervoltage Lockout (UVLO)

The RS3242 family of devices uses an undervoltage lockout circuit to keep the output shut off until the internal circuitry is operating properly.

### 10.5 Disabled

The device is disabled under the following conditions:

- The input voltage is less than the UVLO threshold minus  $V_{HYS}$ , or has not yet exceeded the UVLO threshold.
- The enable voltage is less than the enable falling threshold voltage or has not yet exceeded the enable rising threshold. When disabled, the pull-down device behaves like a  $300\Omega$  resistor to ground.
- The device junction temperature is greater than the thermal shutdown temperature.

## 11 TYPICAL APPLICATION

### 11.1 Input and Output Capacitor Requirements

Although an input capacitor is not required for stability, connecting a minimum of  $1\mu\text{F}$  low-equivalent series resistance (ESR) capacitor across the input supply near the regulator is good analog design practice. This capacitor counteracts reactive input sources and improves transient response and ripple rejection. A higher value capacitor can be necessary if large, fast, rise-time load transients are anticipated or if the device is located several inches from the power source.

The RS3242 family of devices is designed to be stable with standard ceramic output capacitors of values  $4.7\mu\text{F}$  or larger. X5R- and X7R-type capacitors are best because they have minimal variation in value and ESR over temperature.

### 11.2 Adjustable Device Feedback Resistors

The adjustable-version device requires external feedback divider resistors to set the output voltage.  $V_{\text{OUT}}$  is set using the feedback divider resistors,  $R_1$  and  $R_2$ , according to the following equation:

$$V_{\text{OUT}} = V_{\text{FB}} \times (1 + R_1 / R_2) \quad (1)$$

To ignore the FB pin current error term in the  $V_{\text{OUT}}$  equation, set the feedback divider current to 100x the FB pin current listed in the Electrical Characteristics table. This setting provides the maximum feedback divider series resistance, as shown in the following equation:

$$R_1 + R_2 \leq V_{\text{OUT}} / (I_{\text{FB}} \times 100) \quad (2)$$

## 12 POWER SUPPLY RECOMMENDATIONS

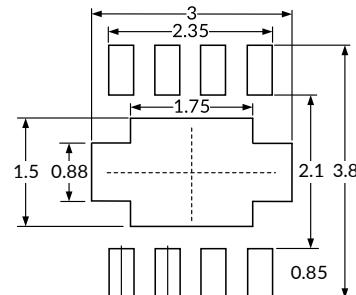
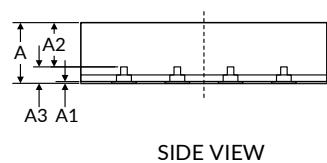
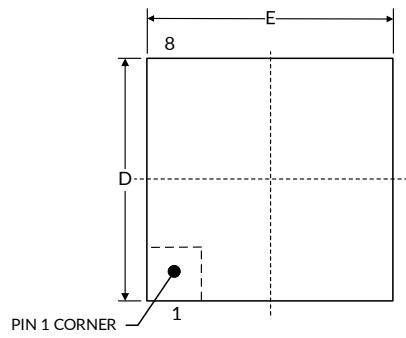
The device is designed to operate from an input voltage supply range between 2.2V and 6V. The input voltage range must provide adequate headroom in order for the device to have a regulated output. This input supply must be well regulated. If the input supply is noisy, additional input capacitors with low ESR can help improve output noise.

## 13 LAYOUT

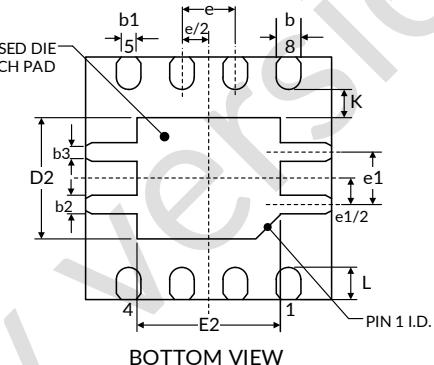
For best overall performance, place all circuit components on the same side of the circuit board and as near as practical to the respective LDO pin connections. Place ground return connections to the input and output capacitor, and to the LDO ground pin as close to each other as possible, connected by a wide, component-side, copper surface. The use of vias and long traces to create LDO component connections is strongly discouraged and negatively affects system performance. This grounding and layout scheme minimizes inductive parasitics, and thereby reduces load-current transients, minimizes noise, and increases circuit stability. A ground reference plane is also recommended and is either embedded in the printed circuit board (PCB) itself or located on the bottom side of the PCB opposite the components. This reference plane serves to assure accuracy of the output voltage, shields the LDO from noise, and behaves similar to a thermal plane to spread (or sink) heat from the LDO device when connected to the exposed thermal pad. In most applications, this ground plane is necessary to meet thermal requirements.

To improve ac performance (such as PSRR, output noise, and transient response), designing the board with separate ground planes for  $V_{IN}$  and  $V_{OUT}$  is recommended, with each ground plane connected only at the GND pin of the device. In addition, the ground connection for the bypass capacitor must connect directly to the GND pin of the device.

## 14 PACKAGE OUTLINE DIMENSIONS DFN3X3-8<sup>(4)</sup>



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A <sup>(1)</sup>	0.700		0.028	
A1	0.000		0.000	
A2	0.550 NOM		0.022 NOM	
A3	0.203 REF <sup>(2)</sup>		0.008 REF <sup>(2)</sup>	
b	0.250	0.350	0.010	0.014
b1	0.180 REF <sup>(2)</sup>		0.007 REF <sup>(2)</sup>	
b2	0.180	0.280	0.007	0.011
b3	0.150 REF <sup>(2)</sup>		0.006 REF <sup>(2)</sup>	
D <sup>(1)</sup>	3.000 BSC <sup>(3)</sup>		0.118 BSC <sup>(3)</sup>	
E <sup>(1)</sup>	3.000 BSC <sup>(3)</sup>		0.118 BSC <sup>(3)</sup>	
e	0.650 BSC <sup>(3)</sup>		0.026 BSC <sup>(3)</sup>	
e1	0.650 BSC <sup>(3)</sup>		0.026 BSC <sup>(3)</sup>	
D2	1.400	1.600	0.055	0.063
E2	1.650	1.850	0.065	0.073
L	0.300	0.500	0.012	0.020
K	0.350 REF <sup>(2)</sup>		0.014 REF <sup>(2)</sup>	

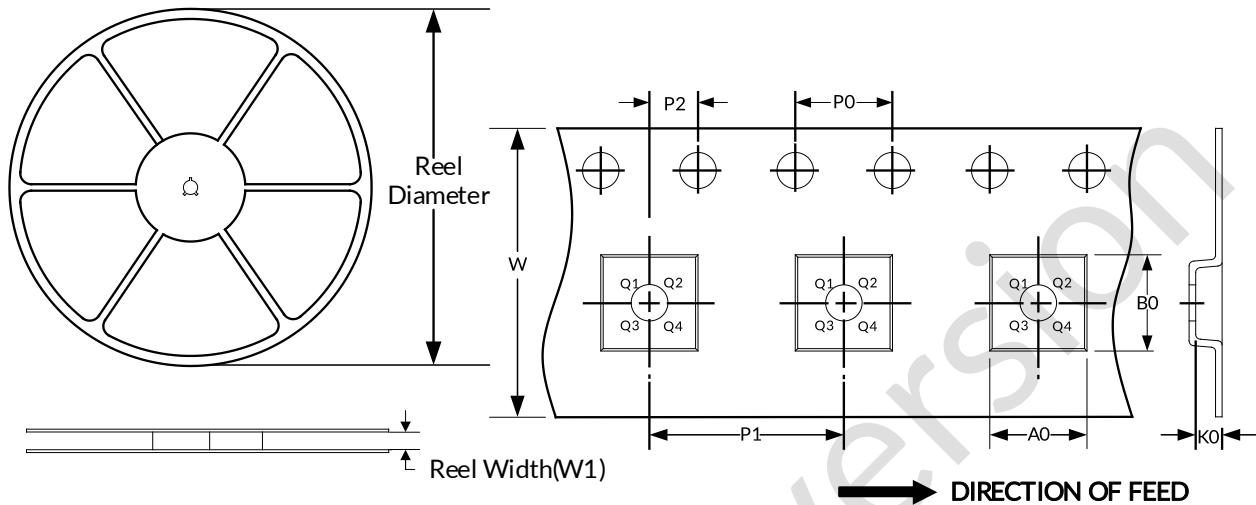
NOTE:

1. Plastic or metal protrusions of 0.075mm maximum per side are not included.
2. REF is the abbreviation for Reference.
3. BSC (Basic Spacing between Centers), "Basic" spacing is nominal.
4. This drawing is subject to change without notice.

## 15 TAPE AND REEL INFORMATION

### REEL DIMENSIONS

### TAPE DIMENSION



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
DFN3X3-8	13"	12.4	3.35	3.35	1.13	4.0	8.0	2.0	12.0	Q2

NOTE:

1. All dimensions are nominal.
2. Plastic or metal protrusions of 0.15mm maximum per side are not included.

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Preliminary Version